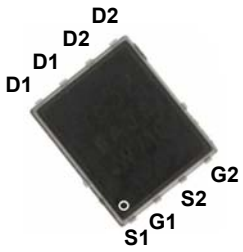
GOOD-ARK SEMICONDUCTOR

GSFP6886

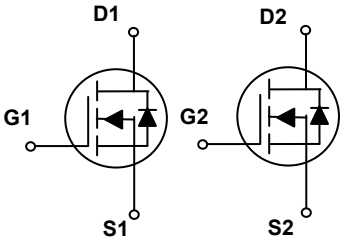
65V Dual N-Channel MOSFET

Main Product Characteristics

BV_{DSS}	65V
$R_{DS(ON)}$	13mΩ
I_D	45A



PPAK5X6



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery

Description

The GSFP6886 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings (T_C=25°C unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	65	V
Gate-Source Voltage	V_{GS}	+20/-12	V
Drain Current-Continuous (T_C=25°C)	I_D	45	A
Drain Current-Continuous (T_C=100°C)		28.5	
Drain Current-Pulsed[1]	I_{DM}	180	A
Single Pulse Avalanche Energy[2]	E_{AS}	20	mJ
Single Pulse Avalanche Current[2]	I_{AS}	20	A
Power Dissipation (T_C=25°C)	P_D	67	W
Power Dissipation-Derate above 25°C		0.54	W/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.86	°C/W
Operating Junction Temperature Range	T_J	-55 To +150	°C
Storage Temperature Range	T_{STG}	-55 To +150	°C

Electrical Characteristics (T_J=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On/Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250uA	65	-	-	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C, I_D=1mA	-	0.03	-	V/°C
Drain-Source Leakage Current	I_{DSS}	V_{DS}=60V, V_{GS}=0V, T_J=25°C	-	-	1	μA
		V_{DS}=48V, V_{GS}=0V, T_J=85°C	-	-	10	μA
Gate-Source Leakage Current	I_{GSS}	V_{GS}=+20V, V_{DS}=0V	-	-	100	nA
Static Drain-Source On-Resistance[3]	$R_{DS(ON)}$	V_{GS}=10V, I_D=20A	-	11	13	mΩ
		V_{GS}=4.5V, I_D=15A	-	18	23	
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}=V_{DS}, I_D=250uA	1	1.5	2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		-	-5	-	mV/°C
Forward Transconductance	g_{fs}	V_{DS}=10V, I_D=3A	-	8	-	S
Dynamic and Switching Characteristics						
Total Gate Charge[3,4]	Q_g	V_{DS}=30V, I_D=20A V_{GS}=10V	-	17.6	26	nC
Gate-Source Charge[3,4]	Q_{gs}		-	2.7	4.1	
Gate-Drain Charge[3,4]	Q_{gd}		-	6.3	9.5	
Turn-On Delay Time[3,4]	$t_{d(on)}$	V_{DD}=30V, R_G=3.3Ω V_{GS}=10V, I_D=1A	-	10	20	nS
Rise Time[3,4]	t_r		-	13.5	27	
Turn-Off Delay Time[3,4]	$t_{d(off)}$		-	28	56	
Fall Time[3,4]	t_f		-	20	40	
Input Capacitance	C_{lss}	V_{DS}=30V, V_{GS}=0V, F=1MHz	-	945	1890	pF
Output Capacitance	C_{oss}		-	275	550	
Reverse Transfer Capacitance	C_{rss}		-	26	52	
Gate Resistance	R_g	V_{GS}=0V, V_{DS}=0V, F=1MHz	-	0.9	-	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	V_G=V_D=0V, Force Current	-	-	55	A
Pulsed Source Current[3]	I_{SM}		-	-	110	A
Diode Forward Voltage[3]	V_{SD}	V_{GS}=0V, I_S=1A, T_J=25°C	-	-	1	V
Reverse Recovery Time	t_{rr}	V_{GS}=10V, I_S=20A di/dt=100A/μs T_J=25°C	-	26	-	nS
Reverse Recovery Charge	Q_{rr}		-	30	-	nC

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. V_{DD}=48V, V_{GS}=10V, L=0.1mH, I_{AS}=20A, R_G=25Ω, starting T_J=25°C.
3. Pulse test: pulse width ≤300us, duty cycle ≤2%.
4. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

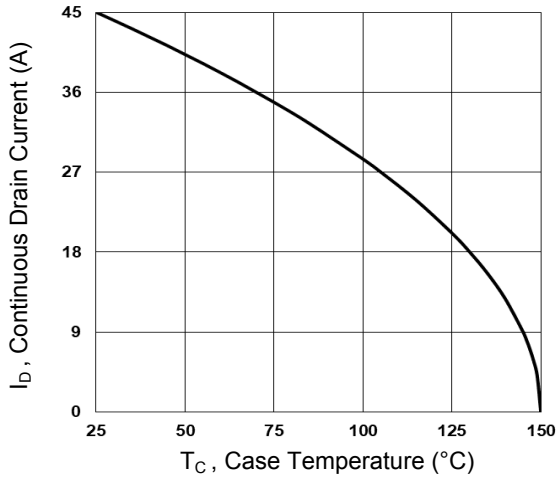


Figure 1. Continuous Drain Current vs. T_C

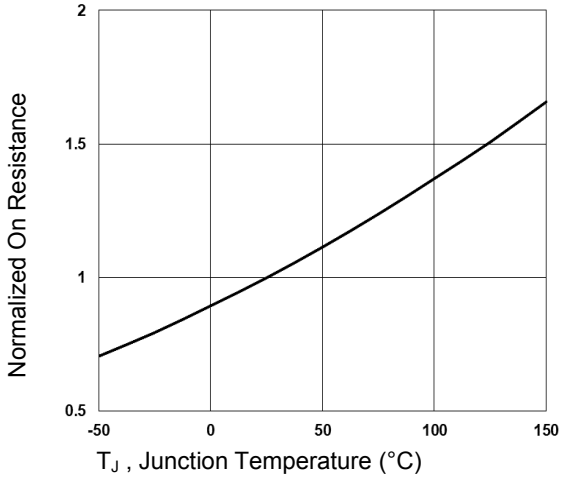


Figure 2. Normalized R_{DSON} vs. T_J

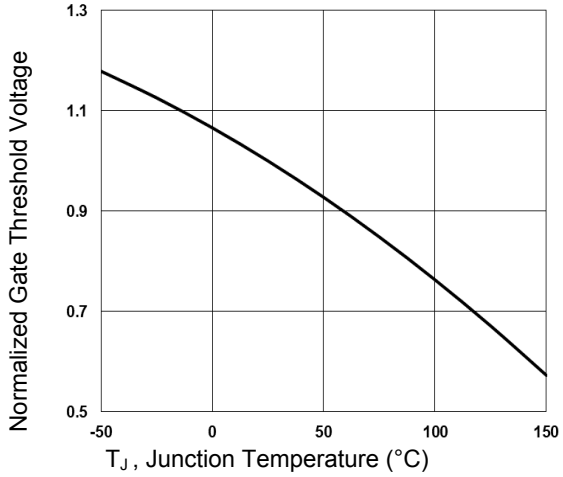


Figure 3. Normalized V_{th} vs. T_J

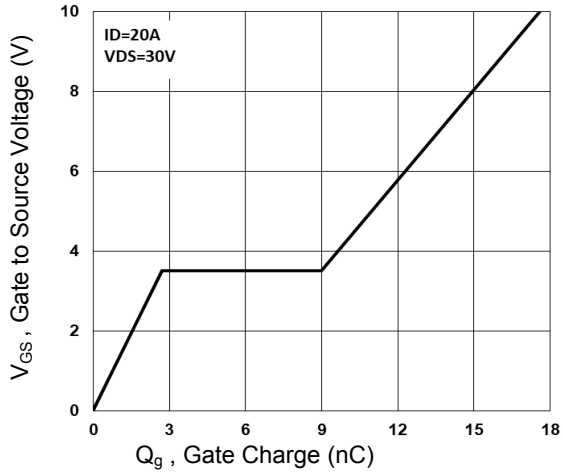


Figure 4. Gate Charge Waveform

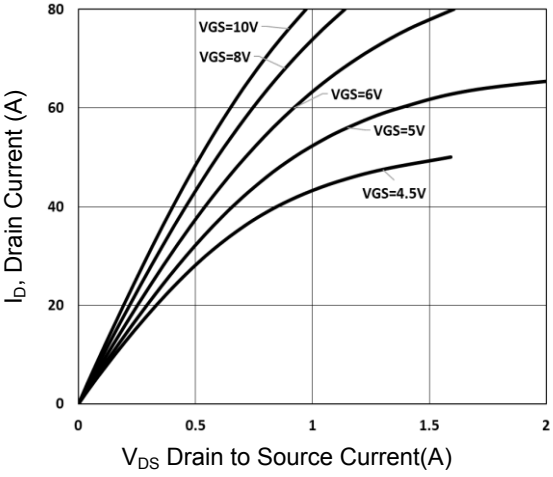


Figure 5. Typical Output Characteristics

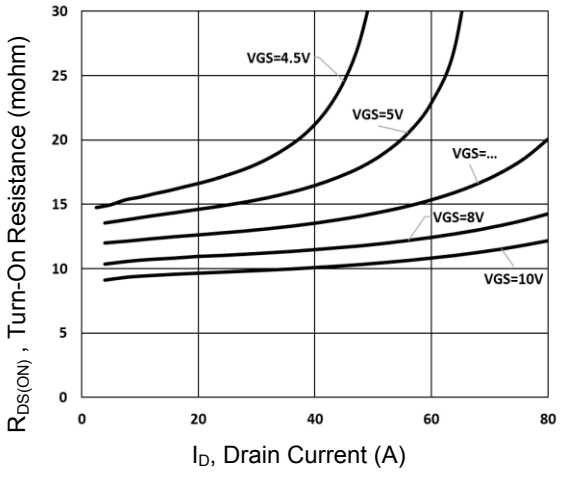


Figure 6. Turn-On Resistance vs. I_D

Typical Electrical and Thermal Characteristic Curves

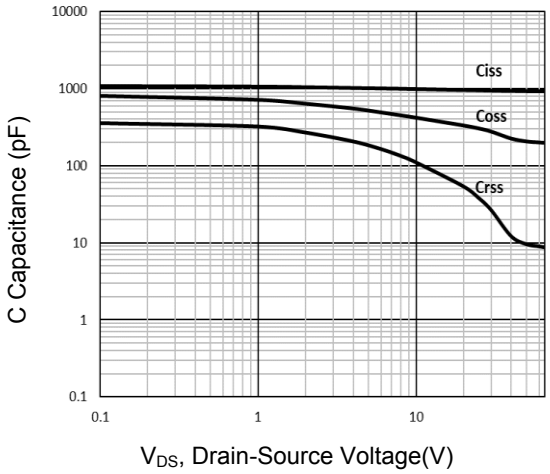


Figure 7. Capacitance vs. V_{DS}

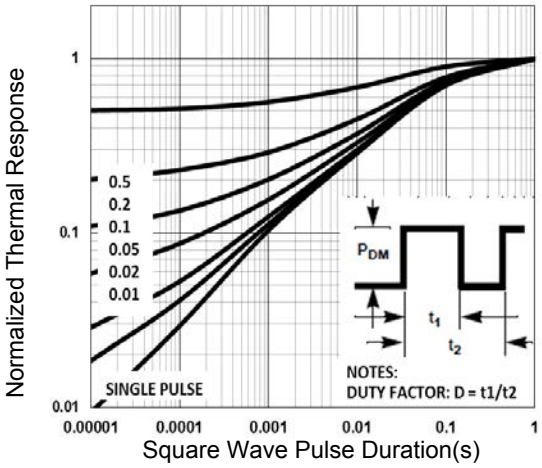


Figure 8. Normalized Transient Response

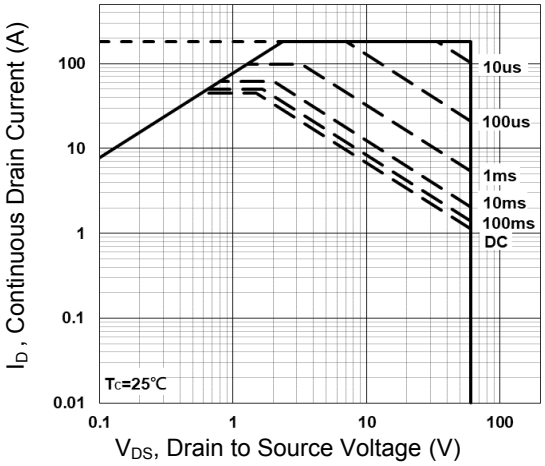


Figure 9. Maximum Safe Operation Area

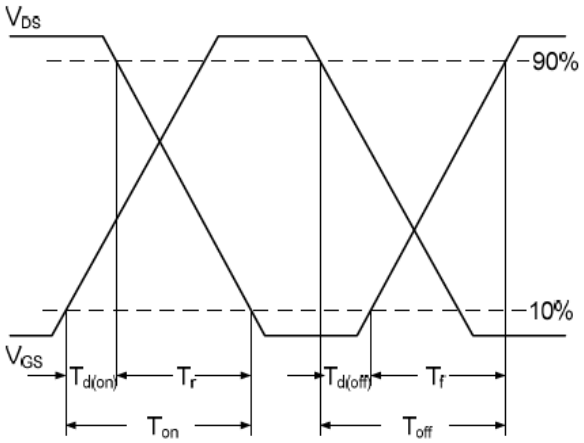


Figure 10. Switching Time Waveform

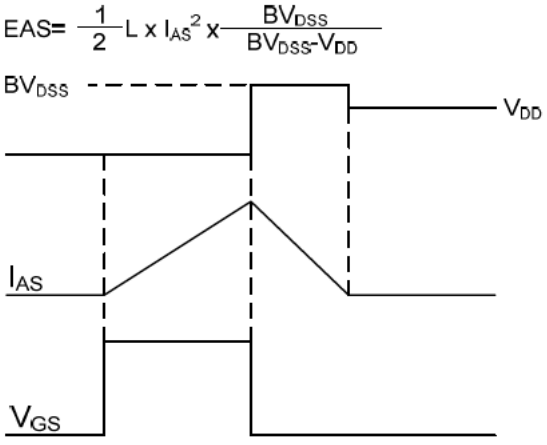
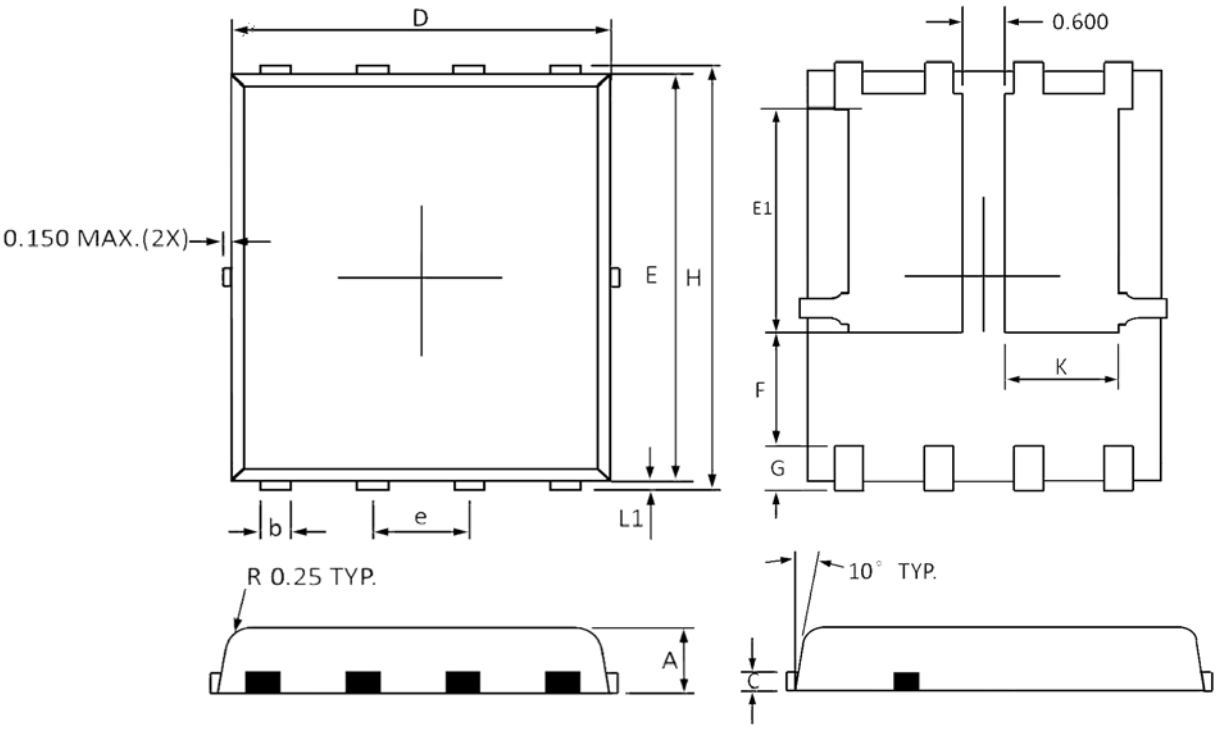


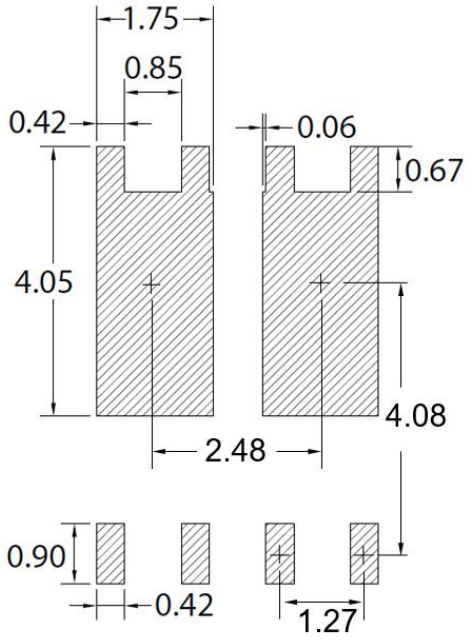
Figure 11. EAS Waveform

Package Outline Dimensions (PPAK5X6)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.200	0.031	0.047
b	0.300	0.510	0.012	0.020
C	0.250 Ref		0.010 Ref	
D	4.800	5.400	0.189	0.213
E	5.450	5.960	0.215	0.235
E1	3.200	3.800	0.126	0.150
e	1.27 BSC		0.050 BSC	
F	1.000	1.900	0.039	0.075
G	0.380	0.800	0.015	0.031
H	5.850	6.300	0.230	0.248
L1	0.050	0.250	0.002	0.010
K	1.500	1.900	0.059	0.074

Recommended Pad Layout



(unit : mm)

Order Information

MPN	Package	Marking	Quantity	HSF Status
GSFP6886	PPAK5x6	DC6886	3000pcs / Reel	RoHS compliant